



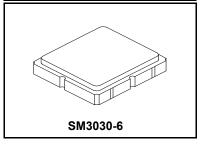
- No Matching Network Required for 50 ΩOperation
- Surface-mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)
- Moisture Sensitivity Level: 1

Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	20	dBm
DC Voltage on any Non-ground Terminal	3	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-20 to +70	°C
Storage Temperature Range in Tape and Reel	-30 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C

SF2208E

1227 MHz SAW Filter

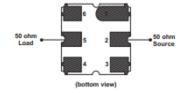


Electrical Characteristics

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency				1227		MHz
Insertion Loss, 1227 MHz				0.95	1.30	40
Amplitude Ripple, 1217 to 1237 MHz				0.1	0.8	dB
Input/Output VSWR, 1217 to 1237 MHz				1.3:1	2.0:1	
Attenuation, 0 dB Reference:						
DC to 600 MHz			10	26.4		
600 to 1177 MHz			10	21.6		dB
1277 to 1290 MHz			20	36.0		
1290 to 3000 MHz	10 25.2		-			
Source Impedance	Z _S			50		Ω
Load Impedance				50		52
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	943, <u>YWWS</u>					
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel					
Reel Size 13 Inch	3000 Pieces/Reel					

Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others

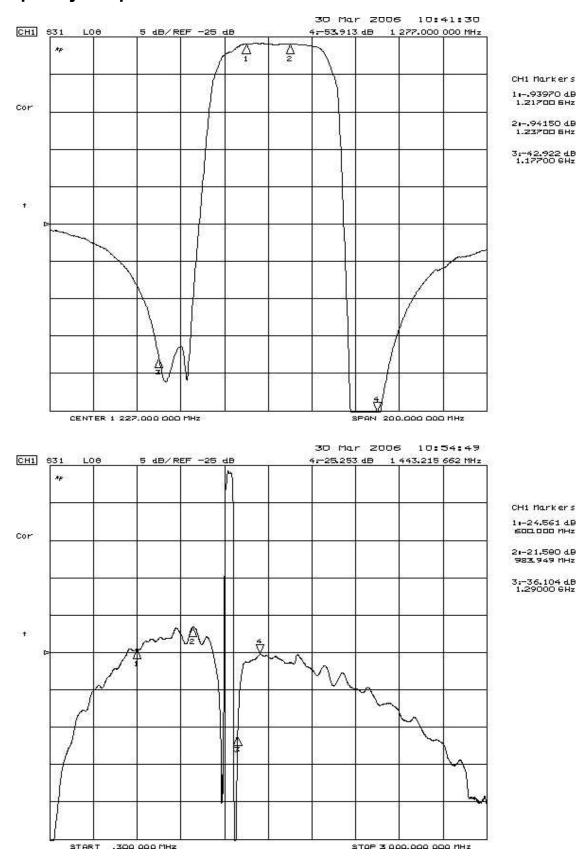




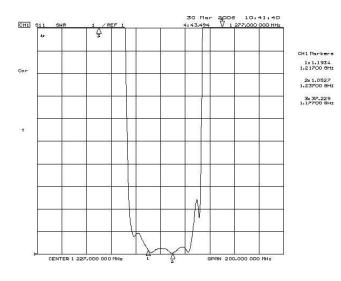
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. **NOTES:**

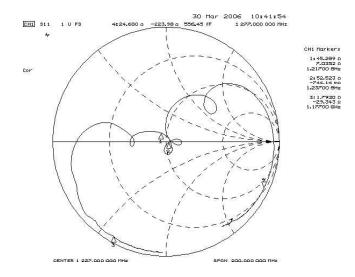
- 1. The design, manufacturing process, and specifications of this device are subject to change.
- 2. US or International patents may apply.
- 3. RoHS compliant from the first date of manufacture.

Filter Frequency Response

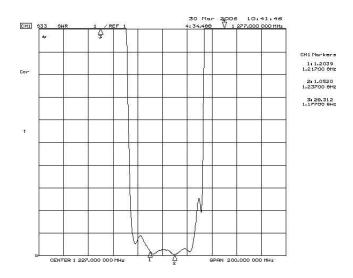


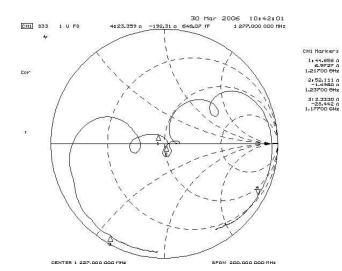
Filter Input Impedance





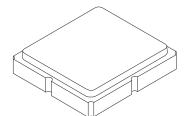
Filter Output Impedance

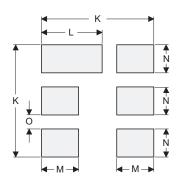




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





PCB Footprint Top View

Case and PCB Footprint Dimensions

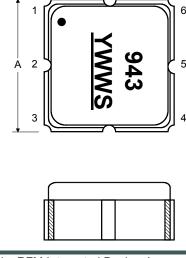
Dimension	mm		Inches			
Difficusion	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
ı	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

Case Materials

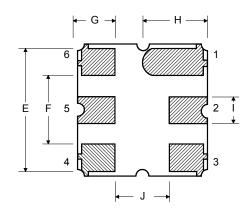
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al ₂ O ₃ Ceramic			

TOP VIEW

- B -



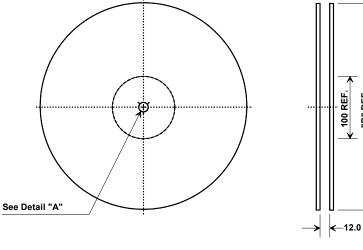
BOTTOM VIEW



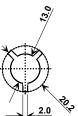
← D →

Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

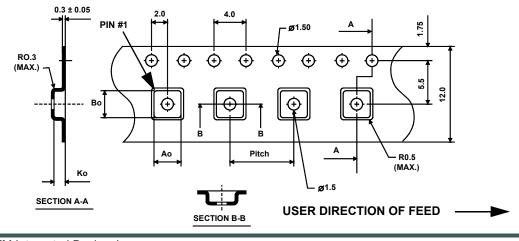


"B"		Quantity Per Reel
Inches	millimeters	quality i or itoo.
7	178	500
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.40 mm			
Pitch	8.0 mm			
W	12.0 mm			



Recommended Reflow Profile

- 1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
- 2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
- 3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
- 4. Time: 5 times maximum.

